



#### 100V N-Channel Enhancement Mode MOSFET

Voltage

100 V

Current

42 A

#### **Features**

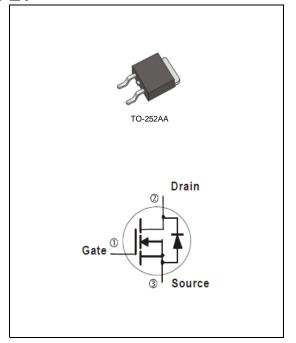
- $R_{DS(ON)}$ ,  $V_{GS}@10V$ ,  $I_{D}@20A<25m\Omega$
- $R_{DS(ON)}$ ,  $V_{GS}@4.5V$ ,  $I_{D}@15A<28.5m\Omega$
- Advanced Trench Process Technology
- High density cell design for ultra low on-resistance
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard



• Case: TO-252AA Package

Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0104 ounces, 0.297 grams



# **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25 °C unless otherwise noted)

| PARAMETER                                        |                       | SYMBOL           | LIMIT       | UNITS |  |
|--------------------------------------------------|-----------------------|------------------|-------------|-------|--|
| Drain-Source Voltage                             |                       | $V_{DS}$         | 100         |       |  |
| Gate-Source Voltage                              |                       | $V_{GS}$         | <u>+</u> 20 | V     |  |
| Continuous Drain Current                         | T <sub>C</sub> =25°C  | I <sub>D</sub>   | 42          | А     |  |
|                                                  | T <sub>C</sub> =100°C |                  | 26          |       |  |
| Pulsed Drain Current (Note 1)                    | T <sub>C</sub> =25°C  | I <sub>DM</sub>  | 150         |       |  |
| Power Dissipation                                | T <sub>C</sub> =25°C  | Po               | 83          | W     |  |
|                                                  | T <sub>C</sub> =100°C |                  | 33          |       |  |
| Continuous Drain Current                         | T <sub>A</sub> =25°C  | I <sub>D</sub>   | 6.3         | А     |  |
|                                                  | T <sub>A</sub> =70°C  |                  | 5.1         |       |  |
| Power Dissipation                                | T <sub>A</sub> =25°C  | Б                | 2.0         | W     |  |
| Power Dissipation                                | T <sub>A</sub> =70°C  | Po               | 1.3         |       |  |
| Single Pulse Avalanche Energy (Note 6)           |                       | E <sub>AS</sub>  | 63.4        | mJ    |  |
| Operating Junction and Storage Temperature Range |                       | $T_J, T_{STG}$   | -55~150     | °C    |  |
| Typical Thermal Resistance <sup>(Note 4,5)</sup> | Junction to Case      | R <sub>θJC</sub> | 1.5         | °C/W  |  |
|                                                  | Junction to Ambient   | $R_{\theta JA}$  | 62.5        |       |  |

• Limited only By Maximum Junction Temperature





## **Electrical Characteristics** (T<sub>A</sub>=25 °C unless otherwise noted)

| PARAMETER                        | SYMBOL              | TEST CONDITION                                                                           | MIN. | TYP. | MAX.         | UNITS |
|----------------------------------|---------------------|------------------------------------------------------------------------------------------|------|------|--------------|-------|
| Static                           |                     |                                                                                          |      |      |              |       |
| Drain-Source Breakdown Voltage   | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                               | 100  | -    | -            | V     |
| Gate Threshold Voltage           | $V_{GS(th)}$        | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA                                 | 1.0  | 1.8  | 2.5          |       |
| Drain-Source On-State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                                                | -    | 20   | 25           | mΩ    |
|                                  |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =15A                                               | -    | 22   | 28.5         |       |
| Zero Gate Voltage Drain Current  | I <sub>DSS</sub>    | V <sub>DS</sub> =80V, V <sub>GS</sub> =0V                                                | -    | -    | 1.0          | uA    |
| Gate-Source Leakage Current      | I <sub>GSS</sub>    | V <sub>GS</sub> = <u>+</u> 20V, V <sub>DS</sub> =0V                                      | -    | -    | <u>+</u> 100 | nA    |
| Dynamic (Note 7)                 |                     | T                                                                                        |      |      |              |       |
| Total Gate Charge                | Qg                  | V <sub>DS</sub> =50V, I <sub>D</sub> =10A,<br>V <sub>GS</sub> =10V <sup>(Note 1,2)</sup> | -    | 29   | -            | nC    |
| Gate-Source Charge               | Q <sub>gs</sub>     |                                                                                          | -    | 4.5  | -            |       |
| Gate-Drain Charge                | $Q_{gd}$            | V <sub>GS</sub> =10V                                                                     | -    | 6.4  | -            |       |
| Input Capacitance                | Ciss                | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V,                                               | -    | 1485 | -            | pF    |
| Output Capacitance               | Coss                | v <sub>DS</sub> =30v, v <sub>GS</sub> =0v,<br>f=1.0MHZ                                   | -    | 135  | -            |       |
| Reverse Transfer Capacitance     | Crss                | I=1.0IVII IZ                                                                             | -    | 67   | -            |       |
| Turn-On Delay Time               | td <sub>(on)</sub>  | V 50V I 10A                                                                              | -    | 7.8  | -            |       |
| Turn-On Rise Time                | t <sub>r</sub>      | $V_{DD}$ =50V, $I_{D}$ =10A, $V_{GS}$ =10V, $R_{G}$ =3 $\Omega$ (Note 1,2)               | -    | 30   | -            | ns    |
| Turn-Off Delay Time              | td <sub>(off)</sub> |                                                                                          | -    | 35   | -            |       |
| Turn-Off Fall Time               | t <sub>f</sub>      | NG=377                                                                                   | -    | 14   | -            |       |
| Drain-Source Diode               |                     |                                                                                          |      |      |              |       |
| Maximum Continuous Drain-Source  | la la               |                                                                                          |      | _    | 42           | Α     |
| Diode Forward Current            | I <sub>S</sub>      |                                                                                          | -    | -    | 44           | ^     |
| Diode Forward Voltage            | V <sub>SD</sub>     | I <sub>S</sub> =1A, V <sub>GS</sub> =0V                                                  | -    | 0.7  | 1.2          | V     |

#### NOTES:

- 1. Pulse width<a>300us</a>, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keep initial  $T_J$  =25°C.
- 4. The maximum current rating is package limited.
- 5. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 6. The test condition is L=3mH,  $I_{AS}$ =6.5A,  $V_{DD}$ =25V,  $V_{GS}$ =10V
- 7. Guaranteed by design, not subject to production testing.





#### **TYPICAL CHARACTERISTIC CURVES**

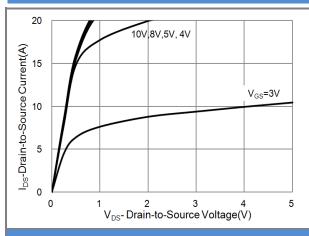
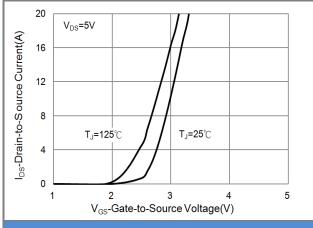


Fig.1 Output Characteristics



**Fig.2 Transfer Characteristics** 

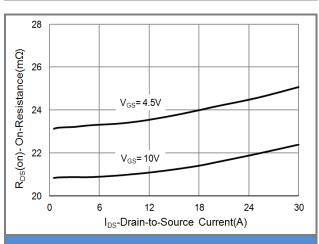


Fig.3 On-Resistance vs. Drain Current

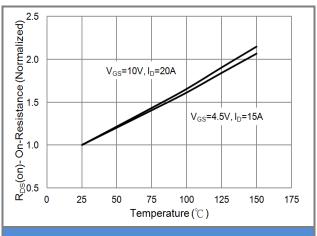
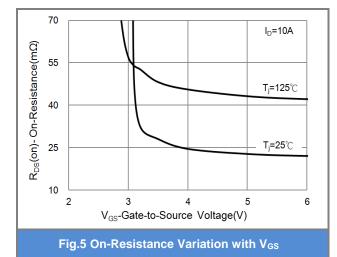


Fig.4 On-Resistance vs. Junction temperature



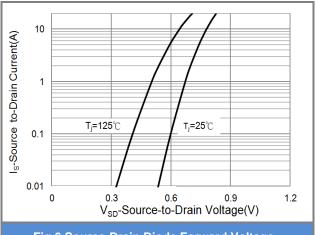
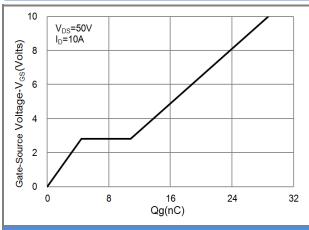


Fig.6 Source-Drain Diode Forward Voltage





#### TYPICAL CHARACTERISTIC CURVES



**Fig.7 Gate-Charge Characteristics** 

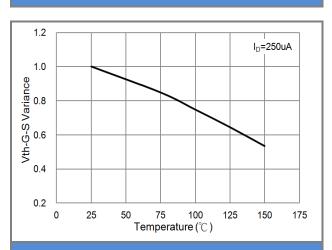
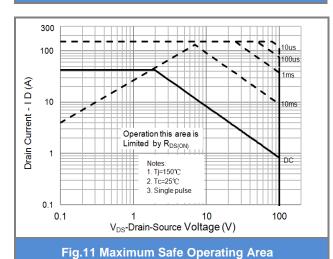


Fig.9 Threshold Voltage Variation with Temperature



TIFICAL CHARACTERISTIC CORVES

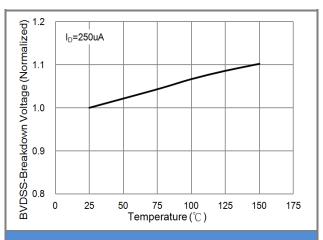


Fig.8 Breakdown Voltage Variation vs. Temperature

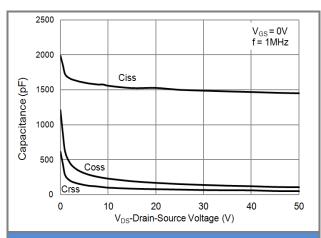


Fig.10 Capacitance vs. Drain-Source Voltage





#### **TYPICAL CHARACTERISTIC CURVES**

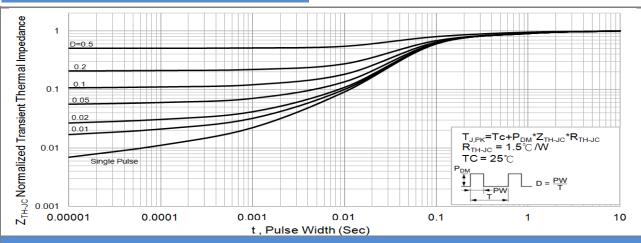


Fig.12 Normalized Transient Thermal Impedance vs. Pulse Width

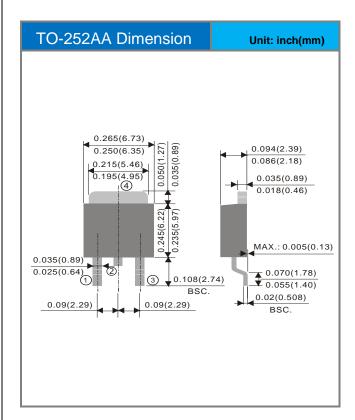


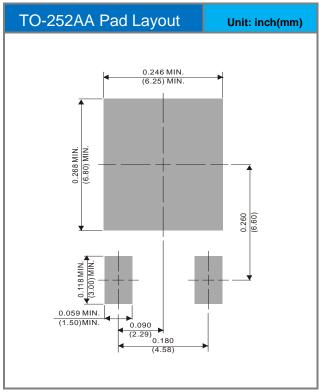


#### **Part No Packing Code Version**

| Part No Packing Code   | Package Type | Packing Type        | Marking | Version      |  |
|------------------------|--------------|---------------------|---------|--------------|--|
| PJD50N10AL-AU_L2_000A1 | TO-252AA     | 3,000pcs / 13" reel | 50N10AL | Halogen free |  |

#### **Packaging Information & Mounting Pad Layout**









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